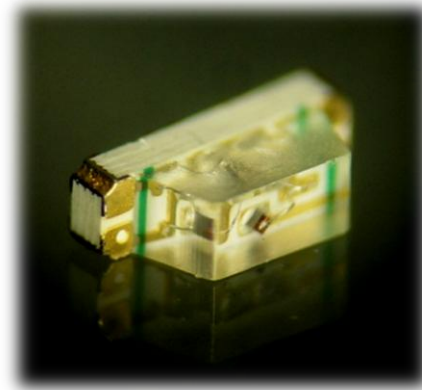


Harvatek Surface Mount CHIP LED Data Sheet B3213GBR-05C0002Q3U1930



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DISCLAIMER

HARVATEK reserves the right to make changes without further notice to any products herein to improve reliability, function or design. HARVATEK does not assume any liability arising out of the application or use of any product or circuit described herein; neither does it convey any license under its patent rights, nor the rights of others.

LIFE SUPPORT POLICY

HARVATEK's products are not authorized for use as critical components in life support devices or systems without the express written approval of the President of HARVATEK or HARVATEK INTERNATIONAL. As used herein:

1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, and (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury of the user.
2. A critical component in any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

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Product Specifications

	Specification	Material	Quantity
Luminous Intensity(Iv)	R :25.0-83.0 mcd G :83.0-292.0 mcd B : 25.0-83.0 mcd R/G/B@5mA/ Ta= 25° C;Tolerance ±10%		
Wavelength	R : 617-630 nm G : 520-535 nm B : 465-475 nm R/G/B@5mA/ Ta= 25° C;Tolerance ± 0.5nm		
Vf	R : 1.6-2.4 V(0.1V) G : 2.5-3.2 V(0.1V) B : 2.5-3.2 V(0.1V) R/G/B@5mA/ Ta= 25° C;Tolerance ± 0.05V		
Ir	< 10 μA @ V _R = 5 V		
Resin	Water clear	Epoxy	
Carrier tape	EIA 481-1A specs	Conductive black tape	
Reel	EIA 481-1A specs	Conductive black	
Label	HT standard	Paper	
Packing bag	250x230mm	Aluminum laminated bag/ no-zipper	One reel per bag
Carton	HT standard	Paper	Non-specified

Others:

Each immediate box consists of 5 reels. The 5 reels may not necessarily have the same lot number or the same bin combinations of Iv, λ_D and Vf. Each reel has a label identifying its specification; the immediate box consists of a product label as well.

ATTENTION: Electrostatic Discharge (ESD) protection

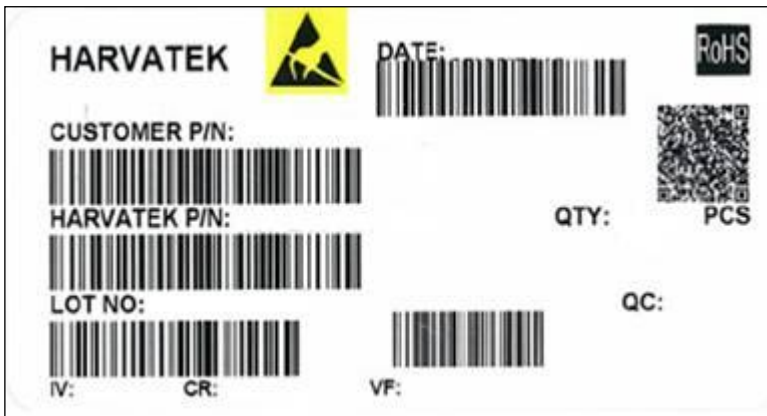


The symbol to the left denotes that ESD precaution is needed. ESD protection for GaP and AlGaAs based chips is necessary even though they are relatively safe in the presence of low static-electric discharge. Parts built with AlInGaP, GaN, or/and InGaN based chips are **STATIC SENSITIVE devices**. ESD precaution must be taken during design and assembly.

If manual work or processing is needed, please ensure the device is adequately protected from ESD during the process.

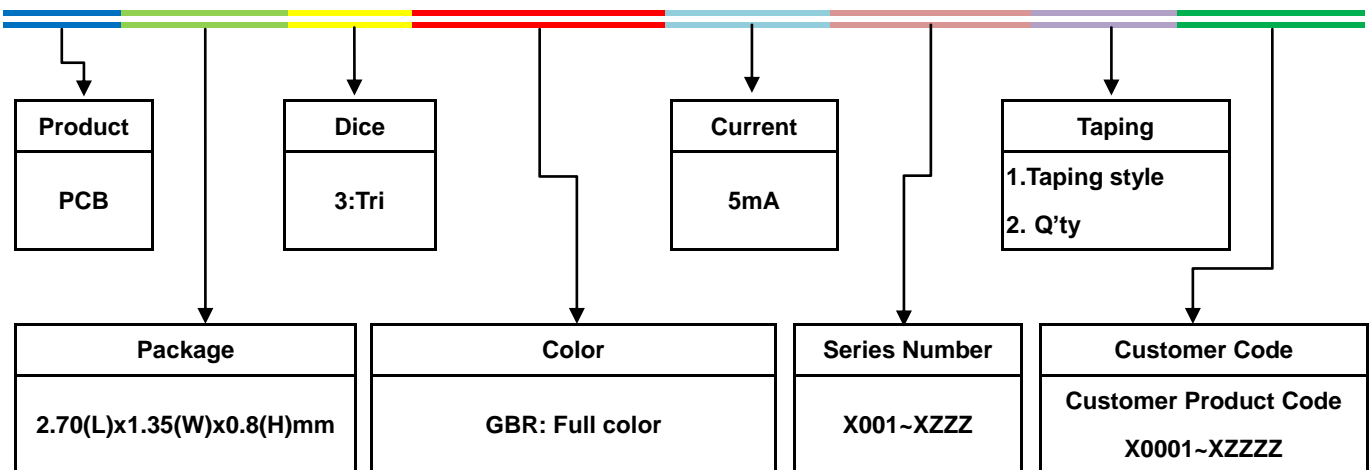
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Label Specifications



Harvatek P/N:

B 321 3 GBR- 05C 0002 Q3 U1930



Lot No.

1	2	3	4	5	6	7	8	9	10
E	1	A	1	A	2	2	L	1	2
Code 1 2		Code 3	Code 4	Code 5	Code 6	Code 7	Code 8	Code 9	Code 10
		Mfg. Year	Mfg. Month	Mfg. Date	Consecutive number		Special code		
Internal Tracing Code		2010-A		1:A	01~ZZ		000~ZZZ		
		2011-B		2:B					
		2012-C	1:Jan.	3:C					
		...	2:Feb.	...					
		2018-I/J	...	26:Z					
		2019-K	A:Oct.	27:7					
		...	B:Nov.	28:8					
2022-N	C:Dec.	29:9							
2023-P	...	30:3							
...	...	31:4							

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Bin code

■ **Luminous Intensity (Iv)**

B3213GBR@5mA bin code								
IV(mcd)								
R			G			B		
CM	25.0	36.0	CR	83.0	127.0	CM	25.0	36.0
CN	36.0	54.0	CS	127.0	195.0	CN	36.0	54.0
CP	54.0	83.0	CT	195.0	292.0	CP	54.0	83.0

Note: It maintains a tolerance of ±10% on IV

■ **Dominant Wavelength (λ_D)**

B3213GBR @5mA bin code					
WD(nm)					
R		G		B	
R	617~630	G1	520~525	B1	465~470
-	-	G2	525~530	B2	470~475
-	-	G3	530~535		

Note: It maintains a tolerance of ±0.5nm on WD

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■ Forward Voltage (Vf)

B3213GBR @5mA bin code					
Vf(V)					
R		G		B	
E1	1.6-1.7	G2	2.5-2.6	G2	2.5-2.6
E2	1.7-1.8	G3	2.6-2.7	G3	2.6-2.7
E3	1.8-1.9	G4	2.7-2.8	G4	2.7-2.8
E4	1.9-2.0	H1	2.8-2.9	H1	2.8-2.9
F1	2.0-2.1	H2	2.9-3.0	H2	2.9-3.0
F2	2.1-2.2	H3	3.0-3.1	H3	3.0-3.1
F3	2.2-2.3	H4	3.1-3.2	H4	3.1-3.2
F4	2.3-2.4				

Note: It maintains a tolerance of $\pm 0.05V$ on Vf

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Product Features

Electro-Optical Characteristics

(I_F Red & Green & Blue@5mA, T_a 25 °C)

Part number	Emitting Color	Forward Voltage(VF)		Wavelength (nm) typ.			I _v (mcd)		IF(mA)	Viewing Angle 2θ1/2
		typ.	max.	λD	λp	Δλ	min.	typ.		
B3213GBR-05	Ultra Bright Red	1.9	2.4	620	628	14	25	42	5	130
	Green	2.9	3.2	532	522	30	83	175		
	Blue	2.9	3.2	470	466	18	25	42		

Unit: mm Tolerance: +/-0.1

Outline Dim.	Soldering Pattern
<p>Soldering terminals may shift in the x, y direction.</p>	

Absolute Maximum Ratings

(T_a 25 °C)

Series	P _D (mW)	I _F (mA)	I _{FP} (mA)*	T _{OP} (°C)	T _{ST} (°C)
Color	Power Dissipation	Forward Current	Pulse Forward Current	Operating Temperature	Storage Temperature
R	48	20	40	-40~+85	-40~+100
G	64	20	60	-40~+85	-40~+100
B	64	20	60	-40~+85	-40~+100

*Condition for I_{FP} is pulse of 1/10 duty and 0.1msec width

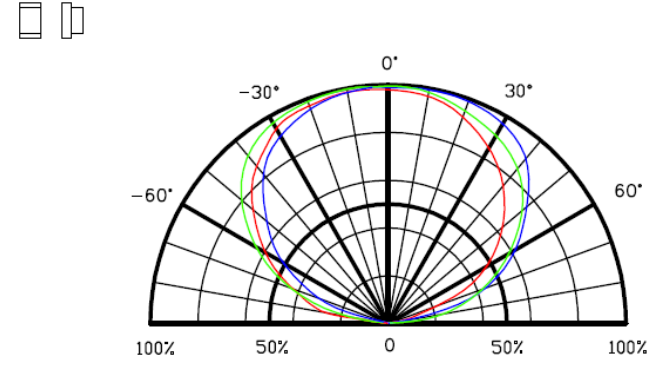
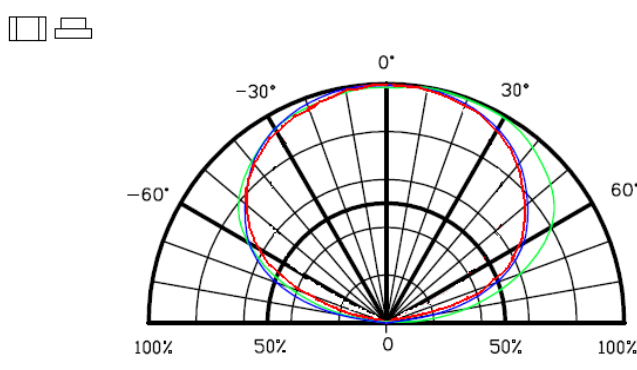
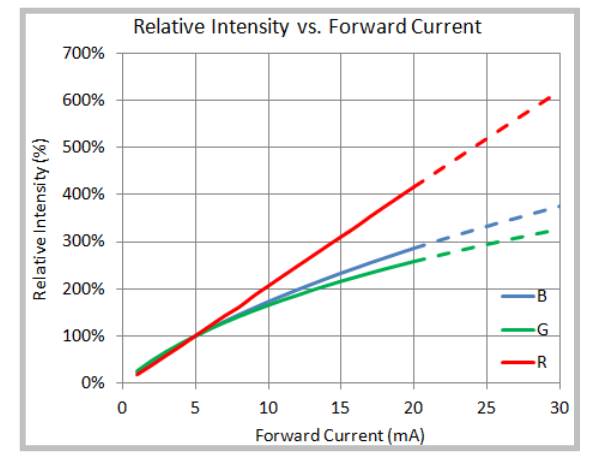
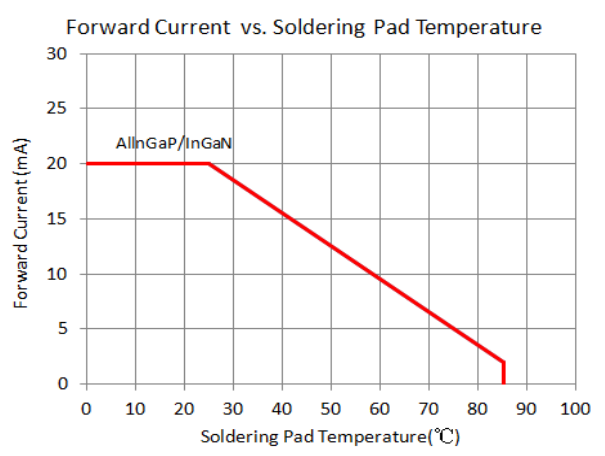
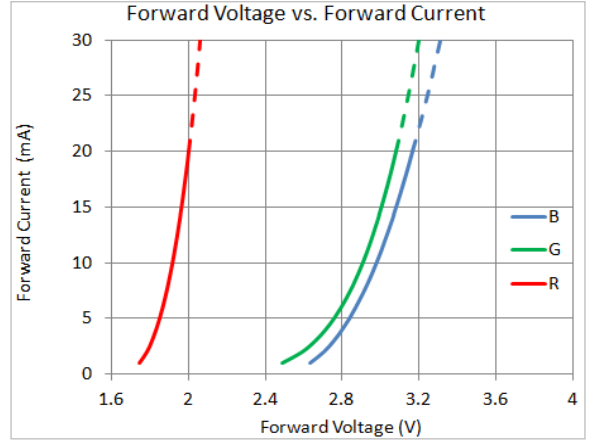
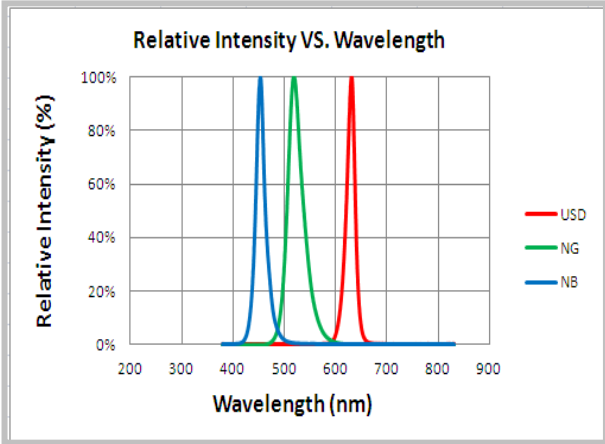
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Precaution for Use

1. The chips should not be used directly in any type of fluid such as water, oil, organic solvent, etc.
2. When the LEDs are illuminating, the maximum ambient temperature should be first considered before operation.
3. LEDs must be stored in a clean environment. A sealed container with a nitrogen atmosphere is necessary if the storage period is over 3 months after shipping.
4. The LEDs must be used within 4 weeks after unpacked. Unused products must be repacked in an anti-electrostatic package, folded to close any opening and then stored in a dry and cool space.
5. The appearance and specifications of the products may be modified for improvement without further notice.
6. The LEDs are sensitive to the static electricity and surge. It is strongly recommended to use a grounded wrist band and anti-electrostatic glove when handling the LEDs. If a voltage over the absolute maximum rating is applied to LEDs, it will damage LEDs. Damaged LEDs will show some abnormal characteristics such as remarkable increase of leak current, lower turn-on voltage and getting unlit at low current.

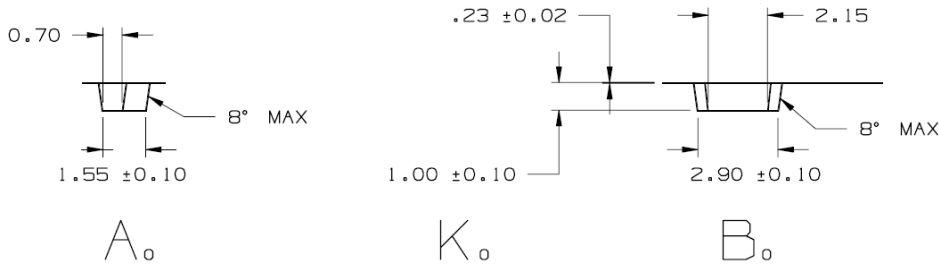
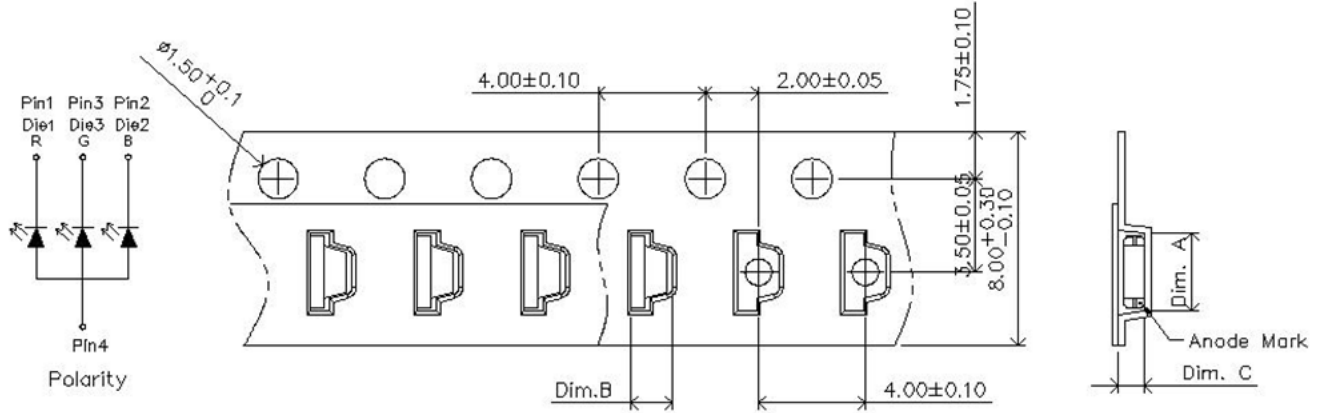
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Characteristics of B3213GBR



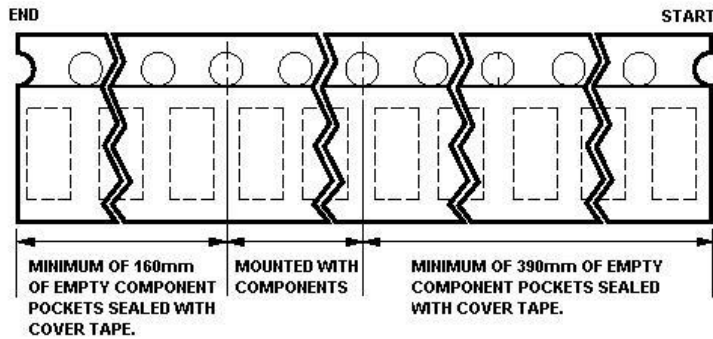
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Packaging
Tape Dimension



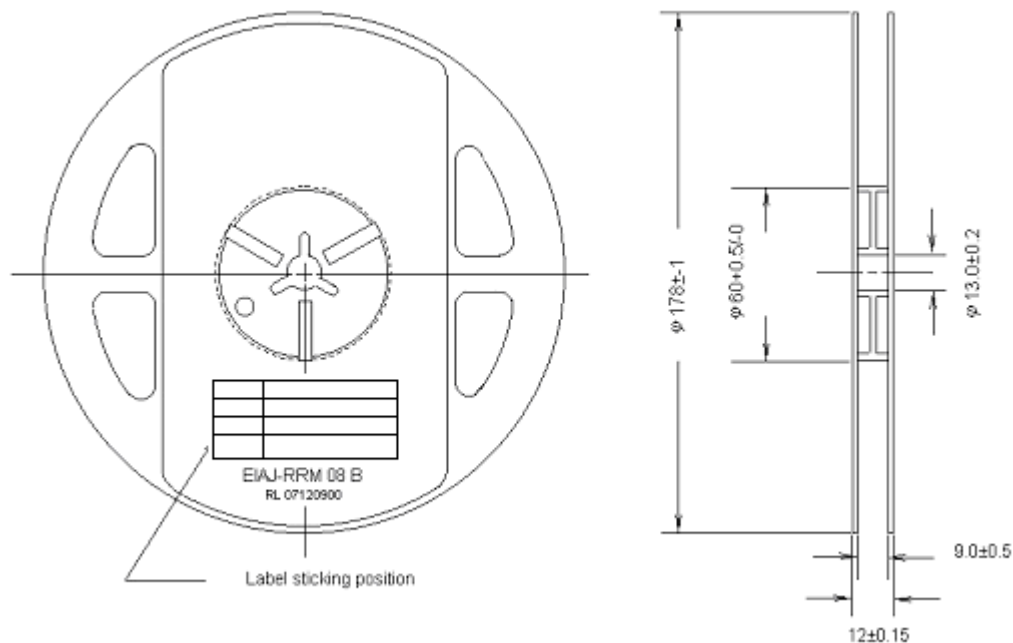
Dim. A	Dim. B	Dim. K0	Q'ty/Reel
2.9±0.10	1.55±0.10	1.00±0.10	3K

Unit: mm

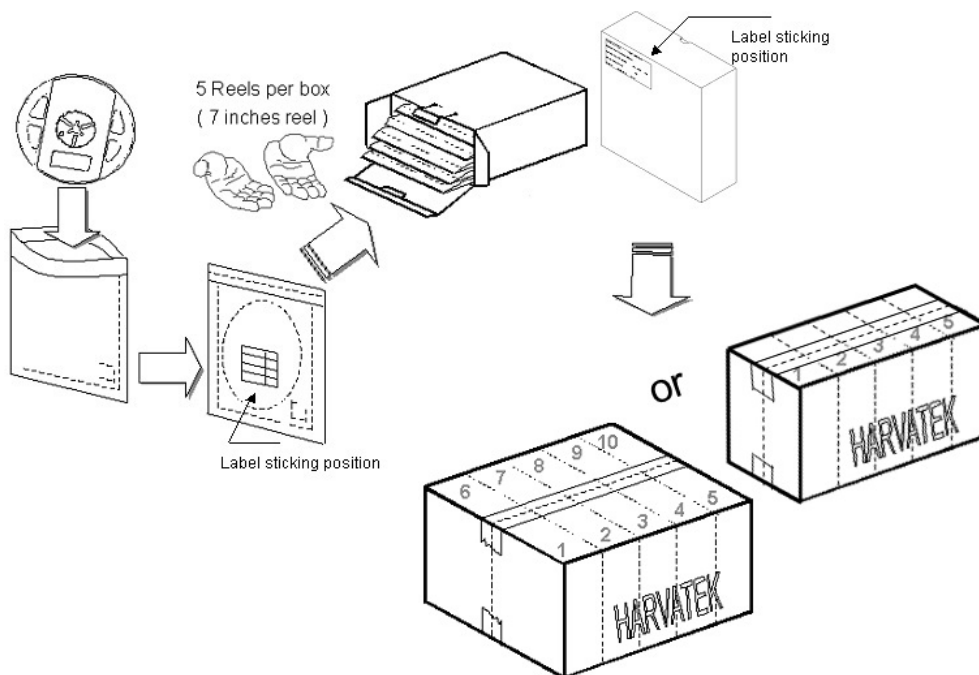


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Reel Dimension



Packing



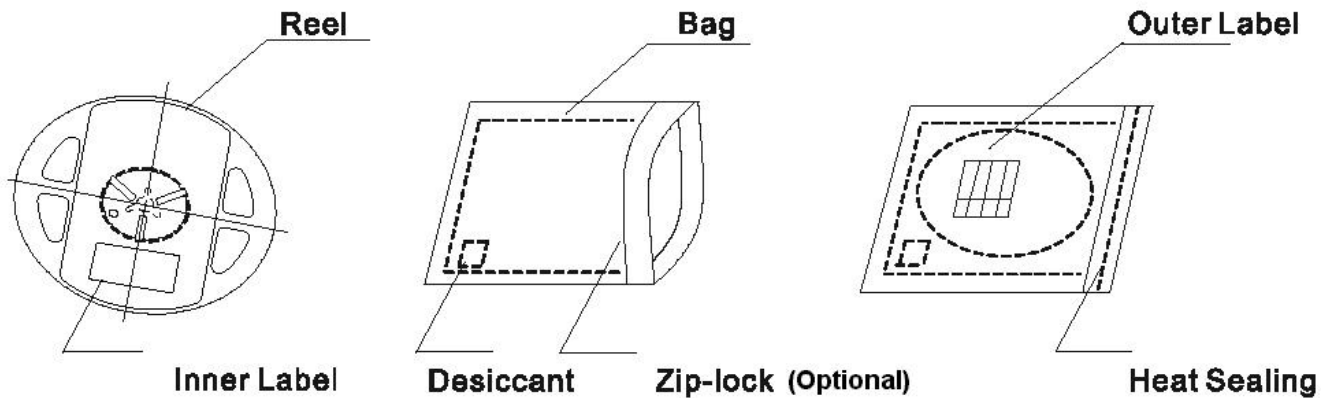
5 or 10 boxes per carton is available depending on shipment quantity.

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Dry Pack

All SMD optical devices are **MOISTURE SENSITIVE**. Avoid exposure to moisture at all times during transportation or storage. Every reel is packaged in a moisture protected anti-static bag. Each bag is properly sealed prior to shipment.

A humidity indicator will be included in the moisture protected anti-static bag prior to shipment. The packaging sequence is as follows:



Baking

Baking before soldering is recommended when the package has been unsealed for 4 weeks. The conditions are as followings:

1. $60\pm 3^{\circ}\text{C} \times (12\sim 24\text{hrs})$ and $< 5\% \text{RH}$, taped reel type.
2. $100\pm 3^{\circ}\text{C} \times (45\text{min}\sim 1\text{hr})$, bulk type.
3. $130\pm 3^{\circ}\text{C} \times (15\text{min}\sim 30\text{min})$, bulk type.

Precautions

1. Avoid exposure to moisture at all times during transportation or storage.
2. Anti-Static precaution must be taken when handling GaN, InGaN, and AlInGaP products.
3. It is suggested to connect the unit with a current limiting resistor of the proper size. Avoid applying a reverse voltage beyond the specified limit.
4. Avoid operation beyond the limits as specified by the absolute maximum ratings.
5. Avoid direct contact with the surface through which the LED emits light.
6. If possible, assemble the unit in a clean room or dust-free environment.

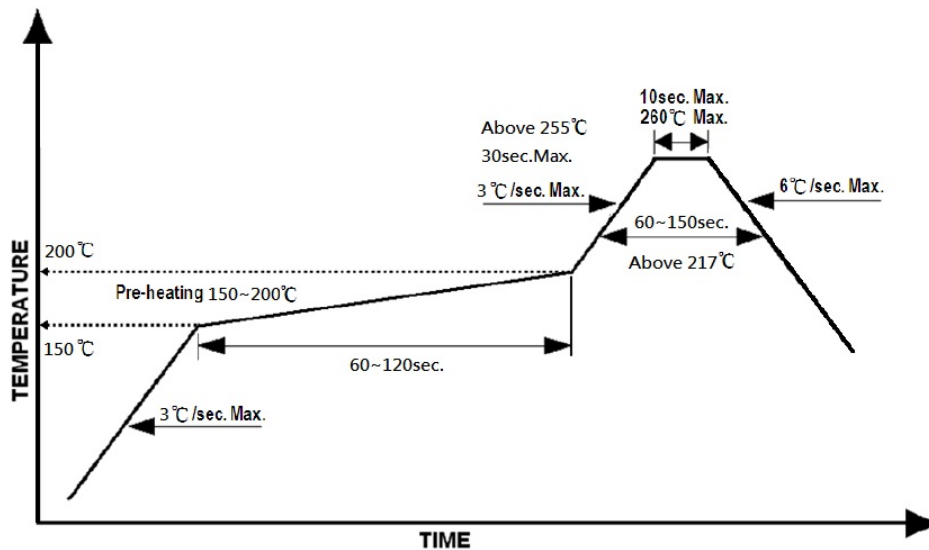
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Reflow Soldering

Recommend soldering paste specifications:

1. Operating temp.: Above 217°C ,60~150 sec
2. Peak temp.:260 °CMax.,10sec Max.
3. Reflow soldering should not be done more than two times.
4. Never attempt next process until the component is cooled down to room temperature after reflow.
5. The recommended reflow soldering profile (measured on the surface of the LED terminal) is as following:

Lead-free Solder Profile.



Reworking

- Rework should be completed within 5 seconds under 260 °C.
- The iron tip must not come in contact with the copper foil.
- Twin-head type is preferred.

Cleaning

Following are cleaning procedures after soldering:

- An alcohol-based solvent such as isopropyl alcohol (IPA) is recommended.
- Temperature x Time should be 50°C x 30sec. or <30°C x 3min
- Ultra sonic cleaning: < 15W/ bath; bath volume ≤ 1liter
- Curing: 100 °C max, <3min

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